

High Performance SMD LED With Reflector
Hyper Red & Super Green Chip LED
Technical Data Sheet

Part No : LL-R3427VUGC-2B

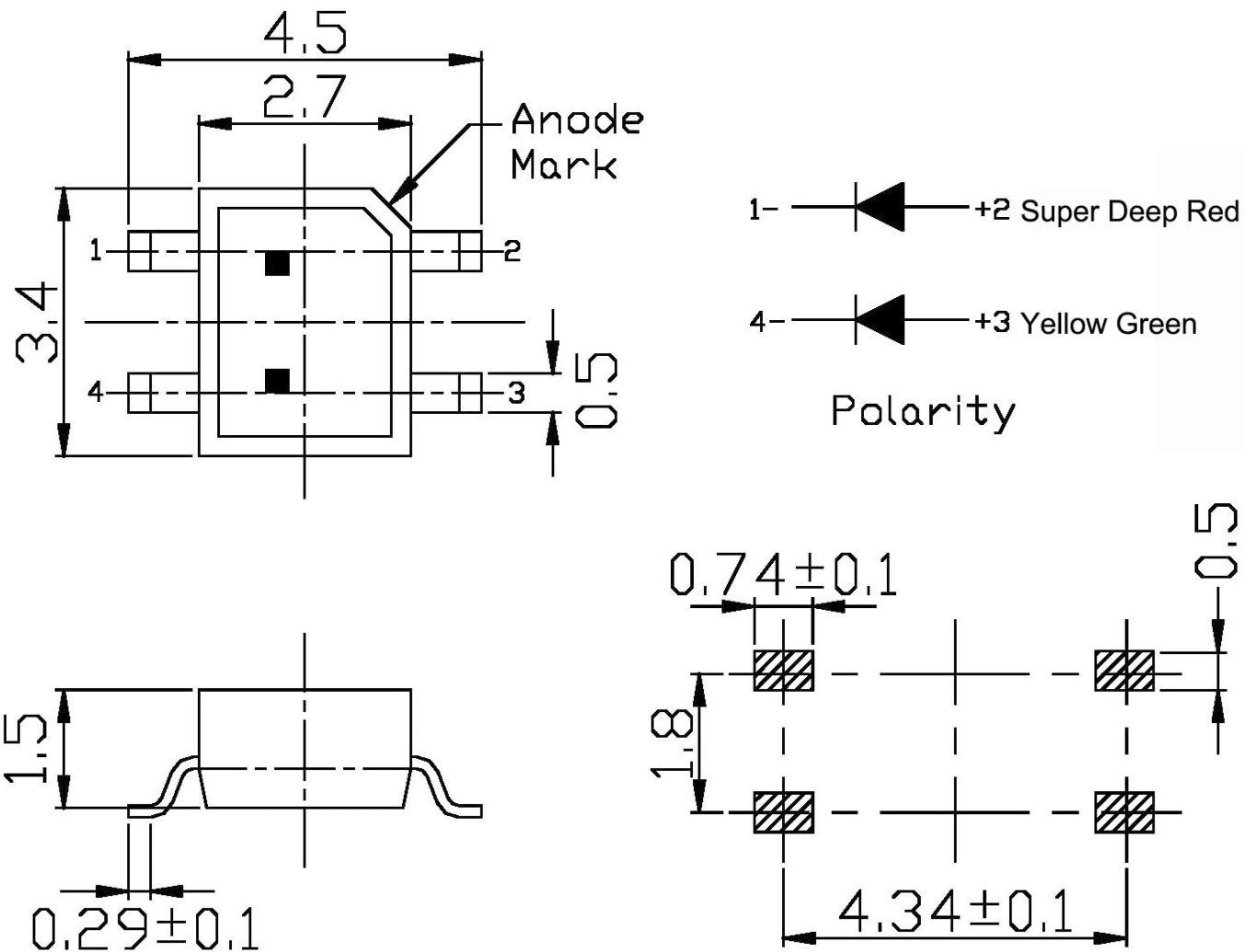


Features

- ◇ Package in 12mm tape on 7" diameter reels.
- ◇ Colorless with automatic placement equipment.
- ◇ Compatible with infrared and vapor phase reflow solder process.
- ◇ EIA std. Package.
- ◇ IC compatible.
- ◇ Pb-Free.
- ◇ The product itself will remain within RoHS Compliant version.

Applications

- ◇ Automotive: backlight in dashboards and switches.
- ◇ Telecommunication: indicator and backlight in telephone and fax
- ◇ Indicator and backlight for audio and video equipment.
- ◇ Indicator and backlight in office and family equipment.
- ◇ Small indicator for outdoor applications.
- ◇ Indicator and backlight in office equipment.
- ◇ Flat backlight for LCD's, switches and symbols.
- ◇ General use.

Package Dimension:


Part No.	Chip Material	Lens Color	Source Color
LL-R3427VUGC-2B	AlGaInP	Water Clear	Hyper Red
	AlGaInP		Super Yellow Green

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.10 (.004") unless otherwise specified.
3. Specifications are subject to change without notice

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Max	Unit
Power Dissipation	PD	70	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	70	mA
Continuous Forward Current	IF	25	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-40°C to +85°C	
Storage Temperature Range	Tstg	-40°C to +90°C	
Soldering Temperature	Tsld	260°C for 5 Seconds	

Electrical Optical Characteristics at Ta=25°C

Parameter	Symbol	Emitting Color	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I _v	Hyper Red	28	50	---	mcd	I _f =20mA Note 1
		Super Yellow Green	20	40	---		
Viewing Angle	2θ _{1/2}	Hyper Red	---	120	---	Deg	Note 2
		Super Yellow Green	---	120	---		
Peak Emission Wavelength	λ _p	Hyper Red	620	625	630	nm	Measurement @Peak
		Super Yellow Green	563	568	573		
Dominant Wavelength	λ _d	Hyper Red	635	640	645	nm	Note 3
		Super Yellow Green	565	570	575		
Spectral Line Half-Width	Δλ	Hyper Red	15	20	25	nm	---
		Super Yellow Green	24	29	34		
Forward Voltage	V _F	Hyper Red	---	2.0	2.4	V	I _F =20mA
		Super Yellow Green	---	2.1	2.4		
Reverse Current	I _R	Hyper Red	---	---	10	μA	V _R =5V
		Super Yellow Green	---	---			

1. Luminous Intensity Measurement allowance is ± 10%
2. θ_{1/2} is the off-axis angle at which the luminous intensity is half the axial luminous intensity

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level:90%

LTPD:10%

1)Test Items and Results

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5℃, Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H:+100℃ 5min ∫ 10 sec L:-10℃ 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H:+100℃ 15min ∫ 5min L:-40℃ 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp:100℃	25pcs	0/1
5	DC Operating Life	1000Hrs.	I _f =20mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp:-40℃	25pcs	0/1
7	High Temperature/ High Humidity	1000Hrs.	85℃/85%RH	25pcs	0/1

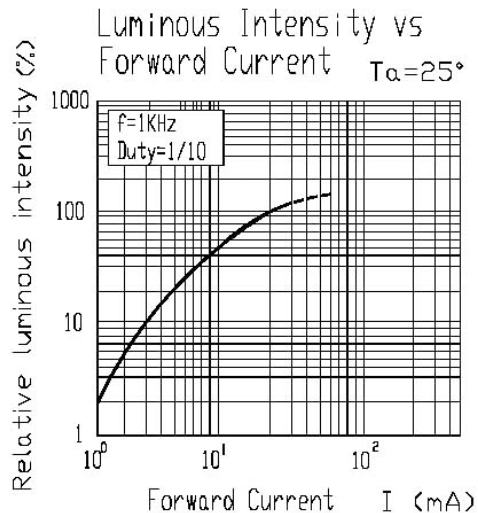
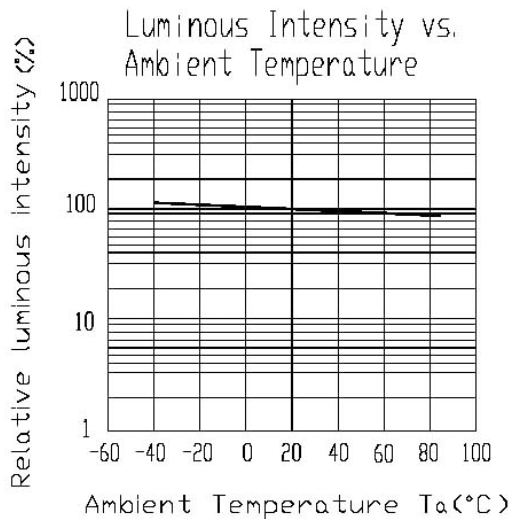
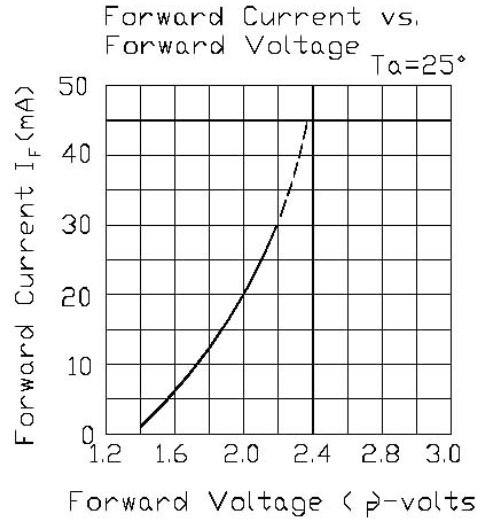
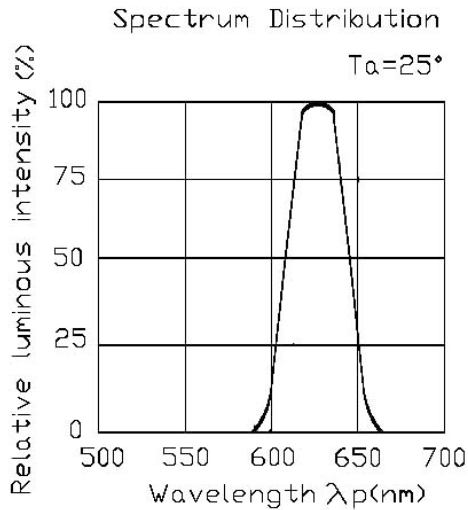
2)Criteria For Judging The Damage

Item	Symbl	Test Conditions	Criteria for Judgement	
			Min	Max
Forward Voltage	VF	I _F =20mA	—	F.V.*)×1.1
Reverse Current	IR	V _R =5V	—	F.V.*)×2.0
Luminous Intensity	IV	I _F =20mA	F.V.*)×0.7	—

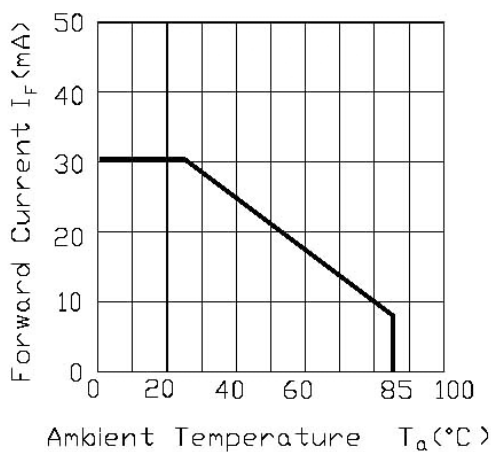
*)F.V.:First Value

Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)

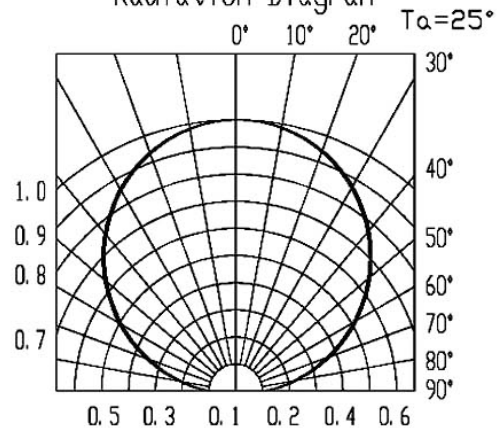
Hyper Red



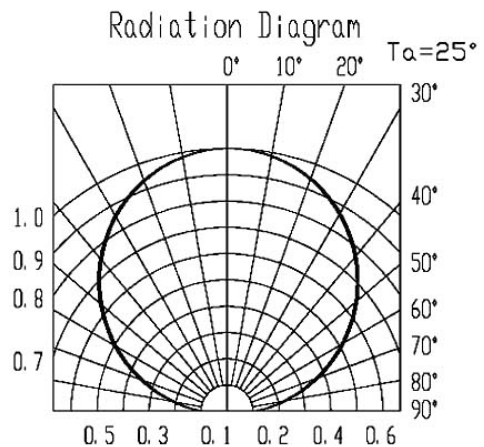
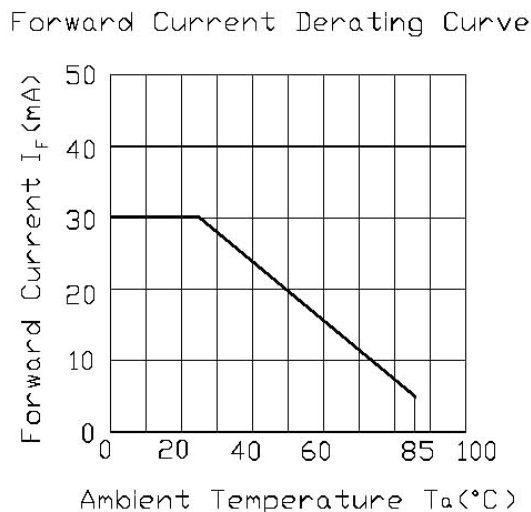
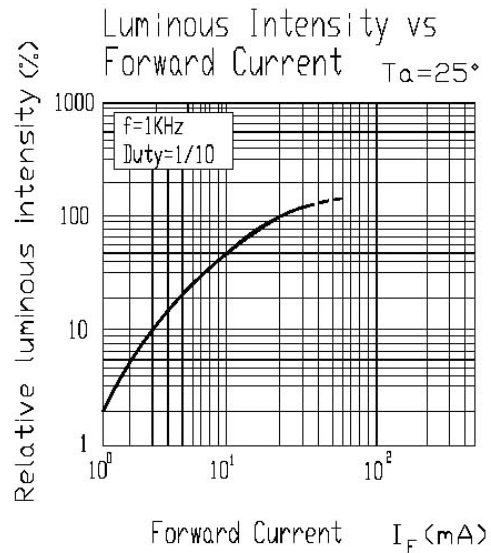
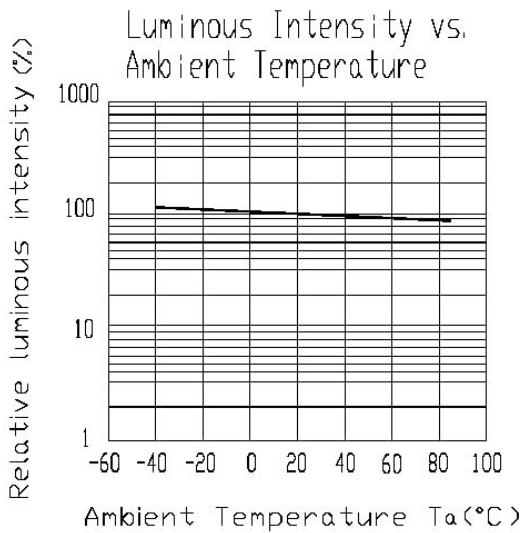
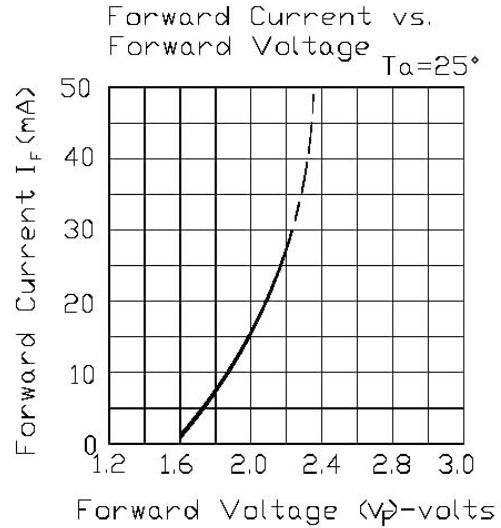
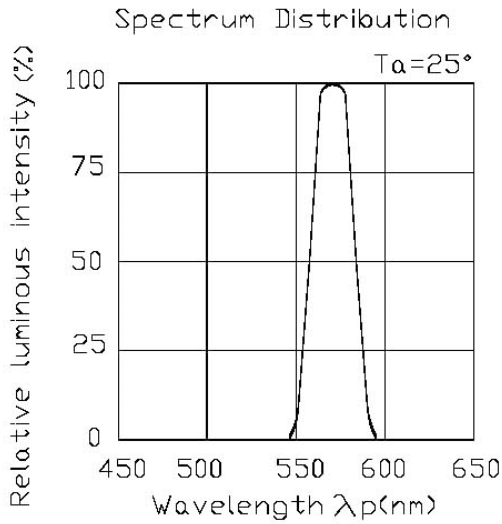
Forward Current Derating Curve



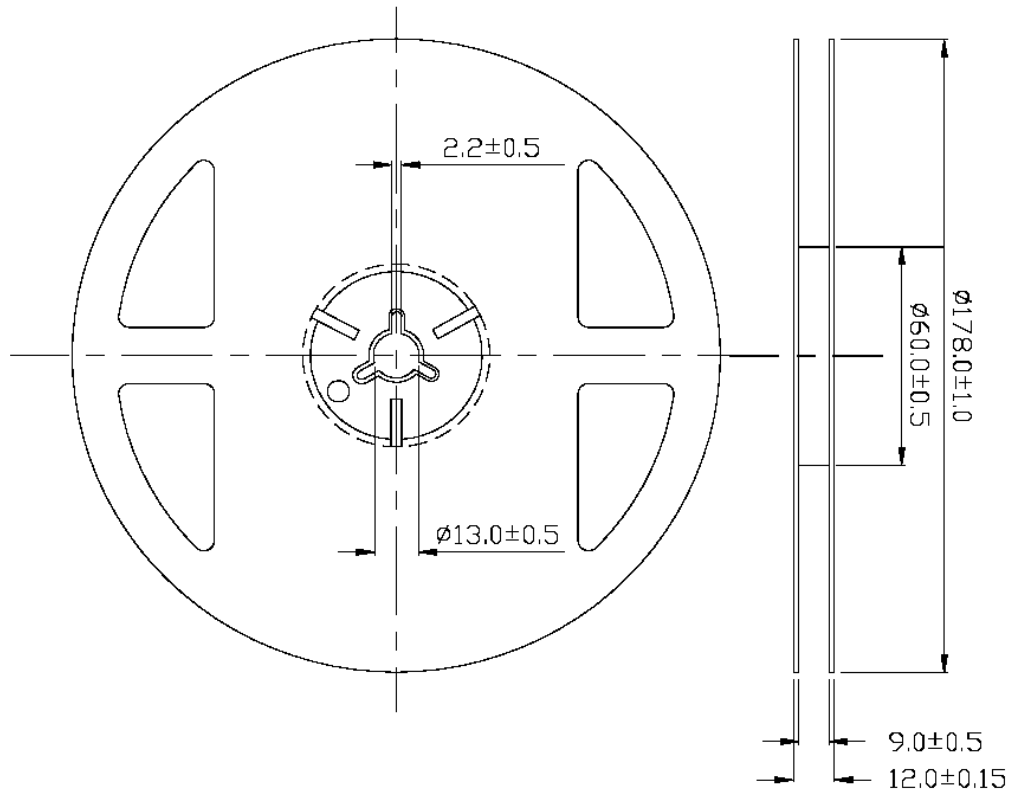
Radiation Diagram



Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted) Super Yellow Green

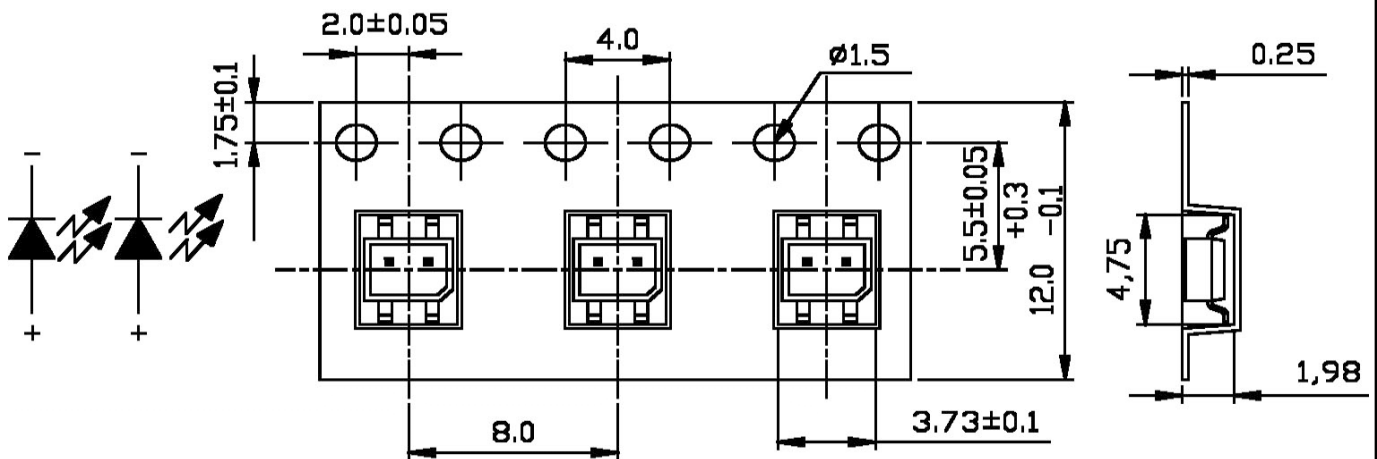


Reel Dimensions



Carrier Tape Dimensions:

Loaded quantity 1000 PCS Per reel



Please read the following notes before using the datasheets

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

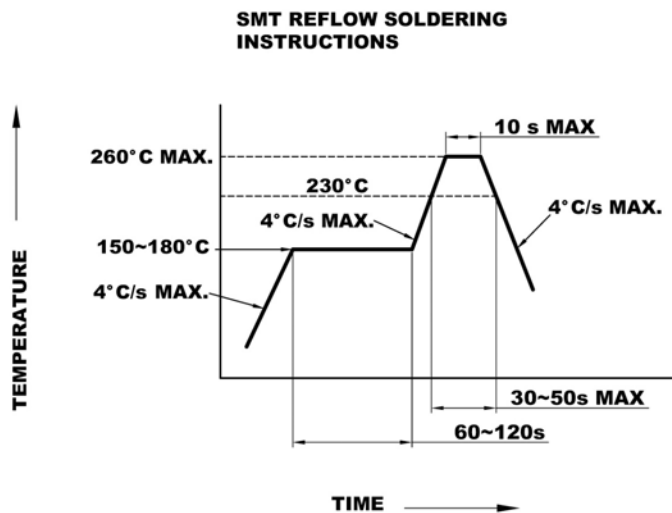
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture adsorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: $60 \pm 5^\circ\text{C}$ for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



SMT Reflow soldering 260°C one cycle

3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering

of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand

whether the characteristics of the LEDs will or will not be damaged by repairing.

